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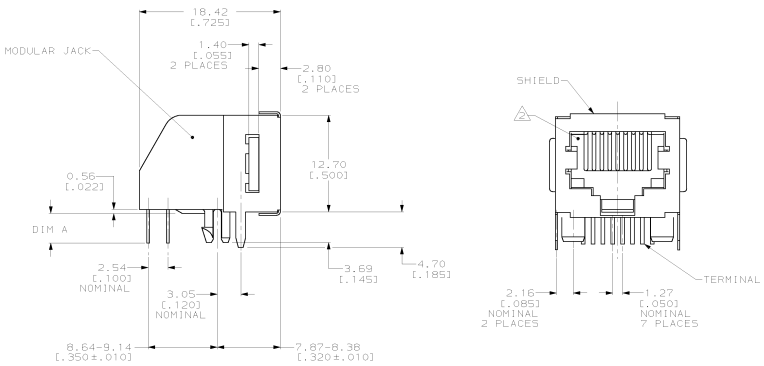
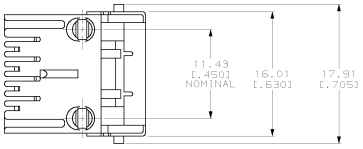
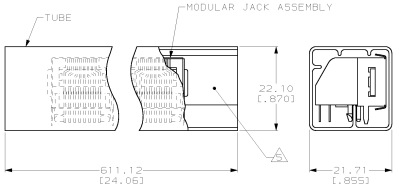
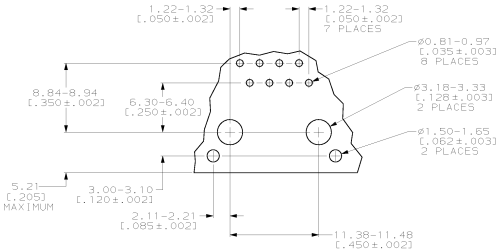
| LTR | DESCRIPTION | DATE | DWN | APVD |
|---|---|---|---|---|
| J | REVISED, EC 01F0-0102-01 | 17AUG01 | DLD | LLV |




DETAIL B
SCALE 2:1




SUGGESTED PRINTED CIRCUIT BOARD
MOUNTING HOLE LAYOUT
(VIEW SHOWN IS CIRCUIT SIDE OF BOARD)

1. MATERIAL:
HOUSING - PBT POLYESTER BLACK.
TERMINAL - 0.36[.014] THICK PHOS-BRONZE PLATED WITH 1.27µm[.000050] THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA AND 2.03µm[.000080] THICK TIN-LEAD IN SOLDER AREA OVER 1.27µm[.000050] THICK NICKEL UNDERPLATE.
SHIELD - 0.25[.010] THICK COPPER ALLOY, TIN-LEAD PLATED.

2. CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68, SUBPART F.

3. DIMENSIONS ARE MAXIMUM UNLESS OTHERWISE SPECIFIED.

4. BULK PACKAGED IN A TRAY.

5. 32 ASSEMBLIES PACKAGED PER TUBE, SEE DETAIL B.

| DIM A | PACKAGED | PART NUMBER |
|---|---|---|
| 1.78-2.79[.09±.02] | 4 | 555153-6 |
| 2.54-3.05[.11±.01] | 4 | 555153-5 |
| 4.06-4.57[.17±.01] | 4 | 555153-4 |
| 3.30-4.32[.15±.02] | 4 | 555153-3 |
| 3.30-4.32[.15±.02] | 4 | 555153-1 |

THIS DRAWING IS A CONTROLLED DOCUMENT.
DRAWN: 29MAY01 C. GALUCCI/UTE
CHK: 29MAY01 J.D. HUSSEY
APVD: 29MAY01 J. TONEY
PRODUCT SPEC: –
APPLICATION SPEC: –
WEIGHT: –
DIMENSIONS: mm[INCHES]
TOLERANCES UNLESS OTHERWISE SPECIFIED: X PLC ±–, X PLC ±–, X PLC ±–, X PLC ±–, X PLC ±–, ANGLES ±–
MATERIAL: 1
FINISH: 1
CUSTOMER DRAWING

AMP Incorporated
Harrisburg, PA 17105-3608

NAME: MODULAR JACK ASSEMBLY, 8 POSITION, SHIELDED, LOW PROFILE, RIGHT ANGLE WITH PRINTED CIRCUIT BOARD GROUND AND PANEL STOPS

SIZE: A1 | CAGE CODE: 00779 | DRAWING NO: C-555153 | RESTRICTED TO: –
SCALE: 4:1 | SHEET: 1 OF 1 | REV: J



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